



**LG**

website:<http://biz.LGservice.com>  
e-mail:<http://www.LGEservice.com/techsup.html>

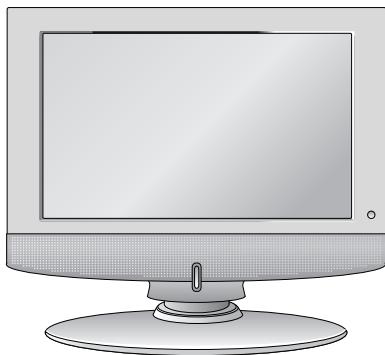
# LCD TV **SERVICE MANUAL**

**CHASSIS : CL-81**

**MODEL : 15LC1RB-MG / 20LC1RB-MG**

## **CAUTION**

BEFORE SERVICING THE CHASSIS,  
READ THE SAFETY PRECAUTIONS IN THIS MANUAL.



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# SAFETY PRECAUTIONS

## IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by  in the Schematic Diagram and Replacement Parts List.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

### General Guidance

An **isolation Transformer** should always be used during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1W), keep the resistor 10mm away from PCB.

Keep wires away from high voltage or high temperature parts.

### Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage of electrical shock.

### Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between  $1M\Omega$  and  $5.2M\Omega$ .

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

### Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

**Do not use a line Isolation Transformer during this check.**

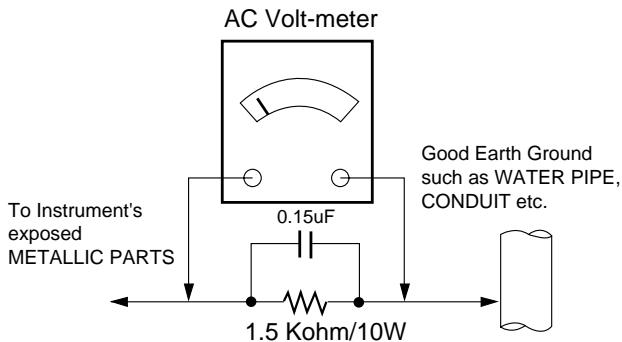
Connect 1.5K/10watt resistor in parallel with a 0.15uF capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

### Leakage Current Hot Check circuit



# SERVICING PRECAUTIONS

**CAUTION:** Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.

**NOTE:** If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions.

Remember: Safety First.

## General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
  - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
  - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
  - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.
- CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.  
Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)  
**CAUTION:** This is a flammable mixture.  
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.  
Always remove the test receiver ground lead last.
8. *Use with this receiver only the test fixtures specified in this service manual.*  
**CAUTION:** Do not connect the test fixture ground strap to any heat sink in this receiver.

## Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called **Electrostatically Sensitive (ES) Devices**. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to

prevent potential shock reasons prior to applying power to the unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
  3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
  4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
  5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
  6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
  7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
- CAUTION:** Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

## General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle.  
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
  - a. Allow the soldering iron tip to reach normal temperature. (500°F to 600°F)
  - b. Heat the component lead until the solder melts.
  - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.  
**CAUTION:** Work quickly to avoid overheating the circuitboard printed foil.
6. Use the following soldering technique
  - a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)
  - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
  - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.  
**CAUTION:** Work quickly to avoid overheating the circuit board printed foil.
  - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

### **IC Remove/Replacement**

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

#### **Removal**

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

#### **Replacement**

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

### **"Small-Signal" Discrete Transistor**

#### **Removal/Replacement**

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

### **Power Output, Transistor Device**

#### **Removal/Replacement**

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

### **Diode Removal/Replacement**

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

### **Fuse and Conventional Resistor**

#### **Removal/Replacement**

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.

3. Solder the connections.

**CAUTION:** Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

### **Circuit Board Foil Repair**

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

#### **At IC Connections**

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

#### **At Other Connections**

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side. Carefully crimp and solder the connections.

**CAUTION:** Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

## DISASSEMBLY



#1



#2 Detached stand assy (Remove the screws)



#3 Disassembly stand assy



#4 Detached Backcover (Remove the screw)



#5 Open the Backcover's latch with jig



#6 Unlock latch between Cabinet and Backcover

# SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

## 1. Application range

This specification is applied to CL-81 chassis.

## 2. Requirement for Test

Testing for standard of each part must be followed in below condition.

- (1) Temperature: 25°C ± 2°C
- (2) Humidity: 65% ± 10%
- (3) Power: Standard input voltage (AC 100-240V, 50/60Hz)
- (4) Measurement must be performed after heat-run more than 30min.
- (5) Adjusting standard for this chassis is followed a special standard.

## 3. General Specification

### 3-1. 15LC1R

No.	Item		Specification	Remark
1	Type		TFT Color LCD Module	LPL
	ActiveDisplay Area		15.0 inches(380.16mm) diagonal(Aspect 4:3)	
	Pixel Pitch [mm]		0.297mm(H)x0.297mm(V)xRGB	
	Electrical Interface		LVDS	
	Color Depth		6BIT, 16,777,216 colors	
	Size [mm]		332.8(H) x 262.2(V) x 18(D)	
	Surface Treatment		Anti-Glare(HAZE 3%), Hard Coating(3H)	
	Operating Mode		Normally Black	
	Back light Unit		4 CCFL(4 lamps)	
	R/T	Typ.	R.T.:5ms + F.T.:11ms(Typ)	

### 3-2. 20LC1R

No.	Item		Specification	Remark
1	Type		TFT Color LCD Module	LPL
	ActiveDisplay Area		20.1 inches(510.54mm) diagonal	
	Pixel Pitch [mm]		0.2125mm(H)x0.6375mm(V)xRGB	
	Electrical Interface		TTL	
	Color Depth		8BIT, 16,777,216 colors	
	Size [mm]		432(H) x 331.5(V) x 25(D)	
	Surface Treatment		Anti-Glare, Hard Coating(3H)	
	Operating Mode		Normally Black	
	Back light Unit		6 CCFL(6 lamps)	
	R/T	Typ.	25ms(R.T.:12ms + F.T.:13ms)	

## 4. Mechanical Specification

No.	Item		Content			Remark
1	Product Dimension		15LC1R/20LC1R			
			Width(W)	Lengh(D)	Height(H)	
		Before Packing	377.6/492.4	242.8/272.8	394.5/483.3	
		After Packing	433/574.0	143/225.0	442/627.0	
2	Product Weight	Only SET	5.6Kg/8.7Kg			
		With BOX	7.7Kg/11.1Kg			

## 5. Reference table-Function

No.	Item	Specification	Remark
1	Teletext	TOP, FLOF	NO
2	REMOCON	NEC Code	NTSC
3	AV Input	1	Rear
4	S-Video Input	1	Rear
5	Component Input	1	Rear
6	PERI TV Connector	Full SCART : 0	NO
7	Ear-phone output	1	Rear
8	2 Carrier Stereo	X	
9	NICAM Stereo	X	
10	2 Carrier Daul	X	
11	NICAM Daul	X	
12	DW(Double Window) Mode	X	
13	MW(Multi Window) Mode	X	
14	Film Mode	X	
15	Noise Reduction	X	
16	Progressive Scan	O	
17	Motion Detection	X	
18	SRS WOW	X	
19	Swivel Speaker	X	
20	EZ-pip	X	
21	ARC	X	
22	DRP	X	
23	DCDI	X	
24	HDCP	X	

## 6.Optical Character

### 6-1. 15LC1R

No.	Item	Specification				Remark
			Min	Typ	Max	
1	Viewing Angle <CR≥10>	R/L, U/D	55/55 40/50	65/65 45/55		
2	Luminance	Luminance(cd/m <sup>2</sup> )	300	400		
		Variation			1.3	
3	Contrast Ratio	CR	300	400		All White/All Black
4	CIE Color Coordinates	WHITE (Normal)	Wx	0.253	0.283	0.313
			Wy	0.268	0.298	0.328
		WHITE (Warm)	Wx	0.283	0.313	0.343
			Wy	0.299	0.329	0.359
		WHITE (Normal)	Wx	0.253	0.283	0.313
			Wy	0.268	0.298	0.328
		WHITE (Cool)	Wx	0.244	0.274	0.304
			Wy	0.256	0.286	0.316

## 6-2. 20LC1R

No.	Item	Specification				Remark
			Min	Typ	Max	
1	Viewing Angle <CR ≥10>	R/L, U/D	85/85 85/85	88/88 88/88		
2	Luminance	Luminance(cd/m <sup>2</sup> )		300	40	
		Variation			1.3	
3	Contrast Ratio	CR		250	350	All White/All Black
4	CIE Color Coordinates	WHITE (Warm)	Wx	0.283	0.313	0.343
			Wy	0.299	0.329	0.359
		WHITE (Normal)	Wx	0.253	0.283	0.313
			Wy	0.268	0.298	0.328
		WHITE (Cool)	Wx	0.244	0.274	0.304
			Wy	0.256	0.286	0.316

## 7.Engineering Specification

### 7-1.General Specification

No	Item	Specification				Remark
1	ENERGE-15LC1R	SYNC(V/H)	VIDEO	POWER CONSUMPTION		LED COLOE
	Normal-15LC1R	On/On	Active	≤ 40W		BLUE
	Sleep Mode-15LC1R (PC Mode)	Off/On	Off	≤ 1W		Amber
		On/Off				
		Off/Off				
	Off Mode-15LC1R		Off	≤ 1W		Off(PC) Amber(TV/AV)
2	Normal-20LC1R	On/On	Active	≤ 65W		BLUE
	Off Misw-20LC1R	Off/Off	Off	≤ 1W(110V) ≤ 1W(220V)		Orange
	D-SUB Pin configuration	1 : RED 3 : BLUE 5 : S.T (GND) 7 : GREEN GND 9 : N.C 11 : ID0(GND) 13 : H-SYNC 15 : SCL	2 : GREEN 4 : ID2 (GND) 6 : RED 8 : BLUE GND 10 : D-GND 12 : SDA 14 : V-SYNC SHELL : GND	10 : DIGITAL GND		
3	Control Function	1) Contrast / Brightness 2) H-Position 3) Tracking : Clock / Phase 4) Auto Configure 5) Reset				

# ADJUSTMENT INSTRUCTION

## 1. Application

This document is applied to 15", 20" LCD TV which is manufactured in Monitor Factory or is produced on the basis of this data.

## 2. Designation

- 2.1 The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- 2.2. Power Adjustment: Free Voltage
- 2.3. Magnetic Field Condition: Nil.
- 2.4. Input signal Unit: Product Specification Standard
- 2.5. Reserve after operation: Above 30 Minutes
- 2.6. Adjustment equipments: Pattern Generator (MSPG-925 or Equivalent), DDC Adjustment Jig equipment, SVC remote controller

## 3. Adjustment

### 3.1 APC

After Manual-Insult, executing APC

### 3.2 ISP UOC file

#### 3.2.1 Required Equipment

- JIG for ISP
- PC that is installed with "WISP" program.
- Control + Power LED PCB Ass'y

#### 3.2.2 ISP Sequence

- 1) Connect main board with JIG for ISP
- 2) Execute "WISP" Program.
- 3) Compare UOC version in BOM with version of hex file.
- 4) Push "Brouse..." button and select hex file.
- 5) Push "Auto Execute" button.
- 6) Occur an Error, push "Erase" button and try again and again. 2)~5)
- 7) After finishing ISP, Must AC off / ON
- 8) Wait LED is not blink anymore

### 3.3 ADC Process

"IIC\_SW" must set "0"(After ISP, automatically set "0")

#### 3.3.1 AV(CVBS) Mode Adjustment

##### 3.3.1.1 Auto Gain/Offset Adjustment

- Select AV(Video) in Input menu
- Signal equipment : MSPG925  
Output Jack : CVBS  
Output Voltage : 700 mVp-p (patt # 29 in MSPG925)  
Resolution : NTSC J - 720 x 480 @59,94Hz (Model #207 in MSPG925)
- Adjust by commanding AUTO\_COLOR\_ADJUST (0xF1) 0x00 0x00 instruction.

#### 3.3.1.2 Confirmation of adjustment process

- We confirm whether "0x01" address of EEPROM "0xA0" is "0xAA" or not.
- If "0x01" address of EEPROM "0xA0" isn't "0xAA", we adjust once more in adjustment line by adjust method of 3.2.1.2.
- We can confirm the ADC values from "0x0C~0x11" addresses in a page "0xA0"

#### 3.3.2 Component Mode Adjustment

##### 3.3.2.1 Auto Gain/Offset Adjustment

- Select Component in Input menu
- Signal equipment : MSPG925  
Output Jack : D4(Japan) or Componen(Except Japan)  
Output Voltage : 700 mVp-p (patt # 8 in MSPG925)  
Resolution 483/60P - 720 x 483p @59.94Hz (Model #212 in MSPG925)
- Adjust by commanding AUTO\_COLOR\_ADJUST (0xF1) 0x00 0x00 instruction.

#### 3.3.2.2 Confirmation of adjustment process

- We confirm whether "0x01" address of EEPROM "0xA0" is "0xAA" or not.
- If "0x01" address of EEPROM "0xA0" isn't "0xAA", we adjust once more in adjustment line by adjust method of 3.2.1.2.
- We can confirm the ADC values from "0x??~0x??" addresses in a page "0xA0"

#### \*Caution\*

If DDC CMD don't work, please check below.

1. Enter SVC menu by SVC Remote controller

2. Enter "ETC" menu

Check please, IIC\_SW is "0" or "1".

- IIC\_SW "0" : DDC Communications.(DDC2AB)

- IIC\_SW "1" : EDID Write/Read (DDC2B) and Factory default.

## 3.4 Function Check

### 3.4.1 Check display and sound

#### "IIC\_SW" must set "1"

- Check Input and Signal items. (cf. work instructions)
- 1. TV
- 2. AV (CVBS/ S-Video)
- 3 Component
- 4. H/P Out

### 3.4.2 DCXO setting

: After finished all function check, "IIC\_SW" must set "0" by pushing "TILT" key in SVC remocon

## 4. Total Assembly line process

### 4.1 Adjustment Preparation

"IIC\_SW" must set "0"

- Above 30 minutes H/run in RF no signal
- 15 Pin D-Sub Jack is connected to the signal of Pattern Generator.

### 4.2 Confirmation of Luminance

- Set Statement  
Input : CVBS  
Contrast : 100(Max)  
Brightness : 50  
CSM : Normal
- Signal equipment displays  
Output Voltage : 700 mVp-p  
Output Mode : Full White pattern (100 IRE)
- Confirm whether luminance is over 300cd or not

### 4.3 Confirmation of Color Coordinate

- Input Full White Pattern
- Set CSM : Normal (9300K)
- Confirm whether  $x = 0.283 \pm 0.03$ ,  $y = 0.298 \pm 0.03$  or not
- Set CSM : Warm (6500K)
- Confirm whether color coordinate is  $x = 0.313 \pm 0.03$ ,  
 $y = 0.329 \pm 0.03$  or not
- Set CSM : Warm (11000K)
- Confirm whether color coordinate is  $x = 0.274 \pm 0.03$ ,  
 $y = 0.286 \pm 0.03$  or not
- After confirming Color coordinates, Must return to Normal

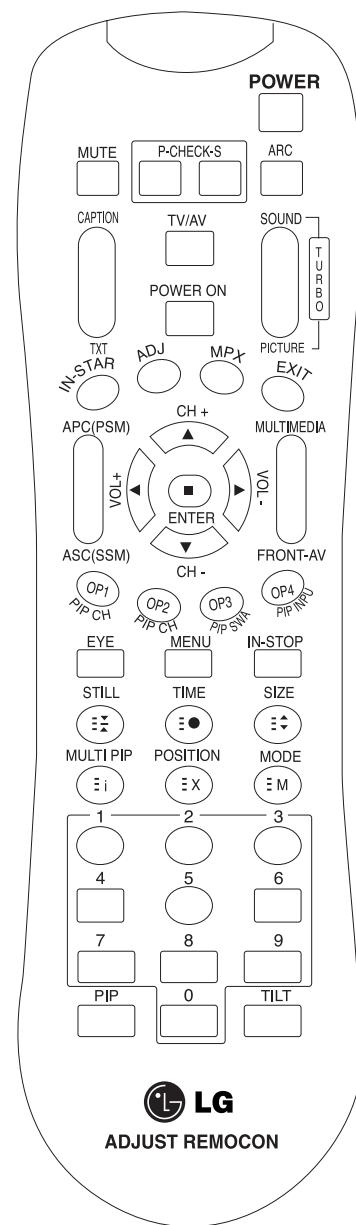
\* After Confirming color coordinate and luminance, "IIC\_SW" must set "1"

## 5. Outgoing Condition

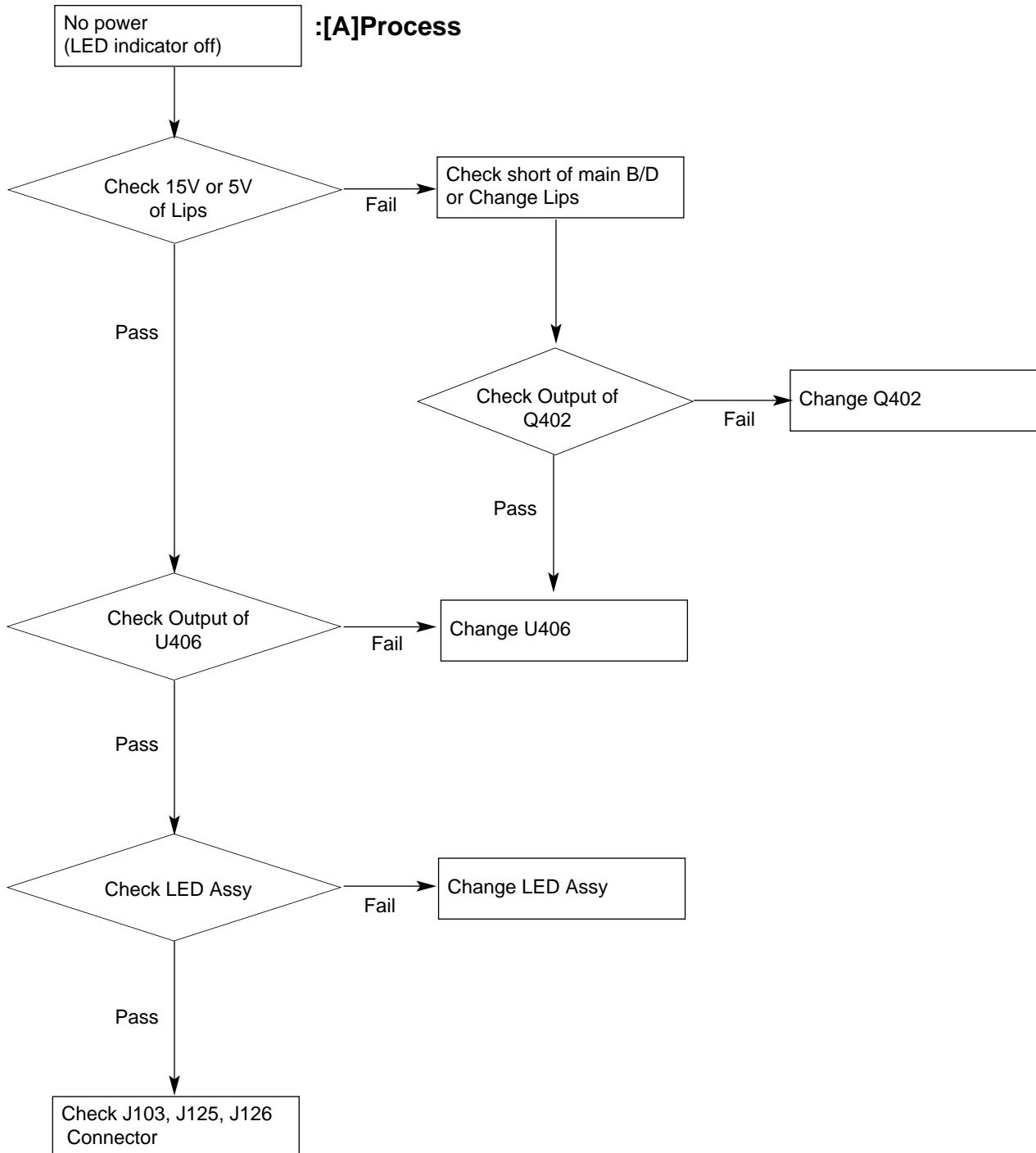
ITEM		Outgoing Condigion			Remarks
Outgoing Condition	Input Source	TV			
	Volume Level	30			
	Power S/W	Off			
	Channel	EZ scan	To Start		
		Manual Program	TV	2	
			Erase		
			Fine	0	
	Picture	EZ Video	Clear		
		ACC	Normal		
	Sound	AVL	Off		
		Balance	0		
	Timer	Clock	Auto ►		
		Off Timer	--:--		
			Off		
		On Timer	--:--		
			TV 2		
			Volume 30		
			Off		
		Auto Off	Off		
	Special	Language	English		Canada/ USA Only
		Input	TV		
		Key lock	Off		
		Power indicator	On		
		Caption/Text	CC1		
		Captions	Off		
		Parental	To set (Code : 0000)		
	Screen	Auto Configure	To Set		Only RGB PC INPUT
		Manual Configure	To Set		
		Reset	To Set		

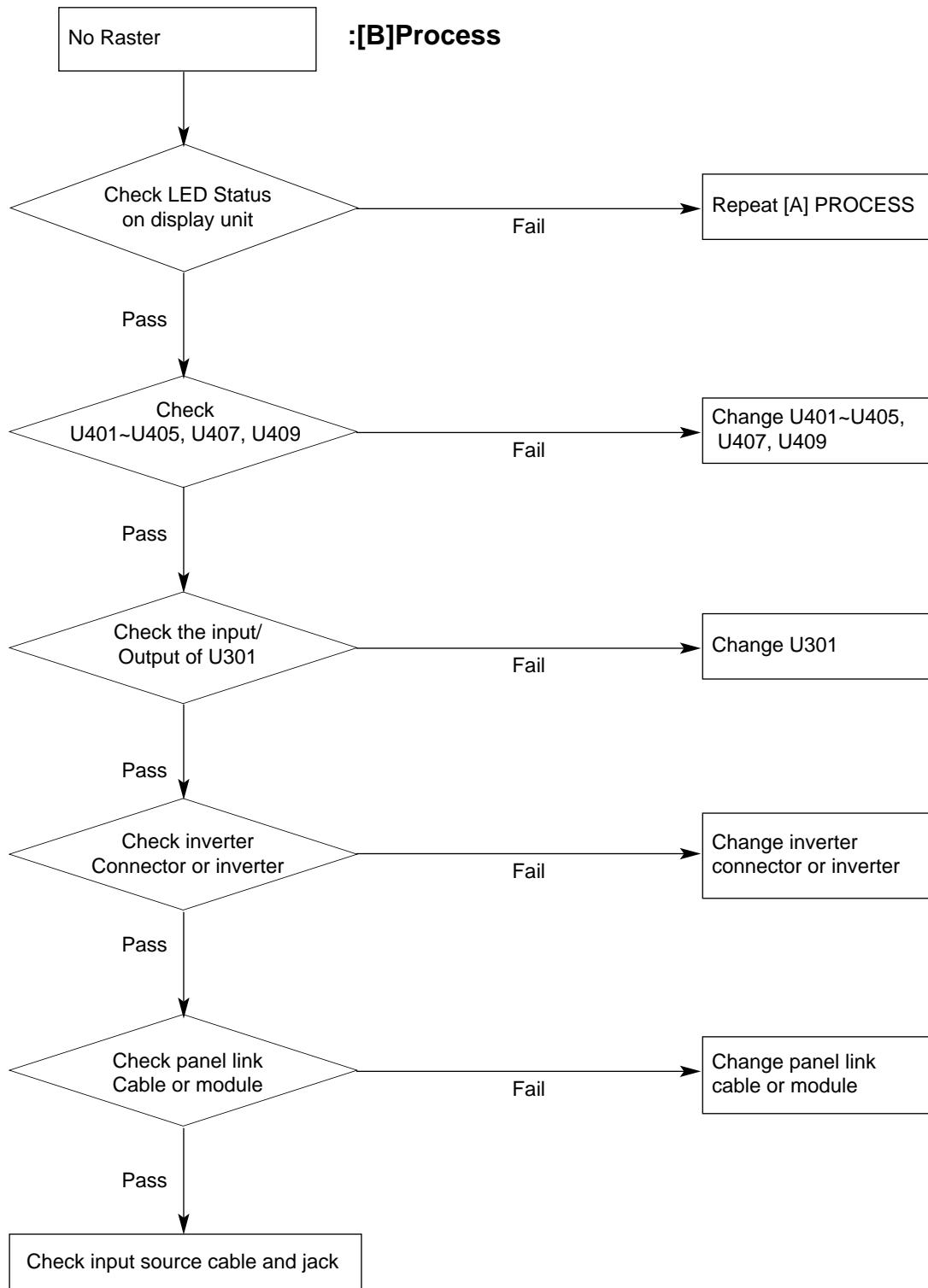
# SVC REMOCON

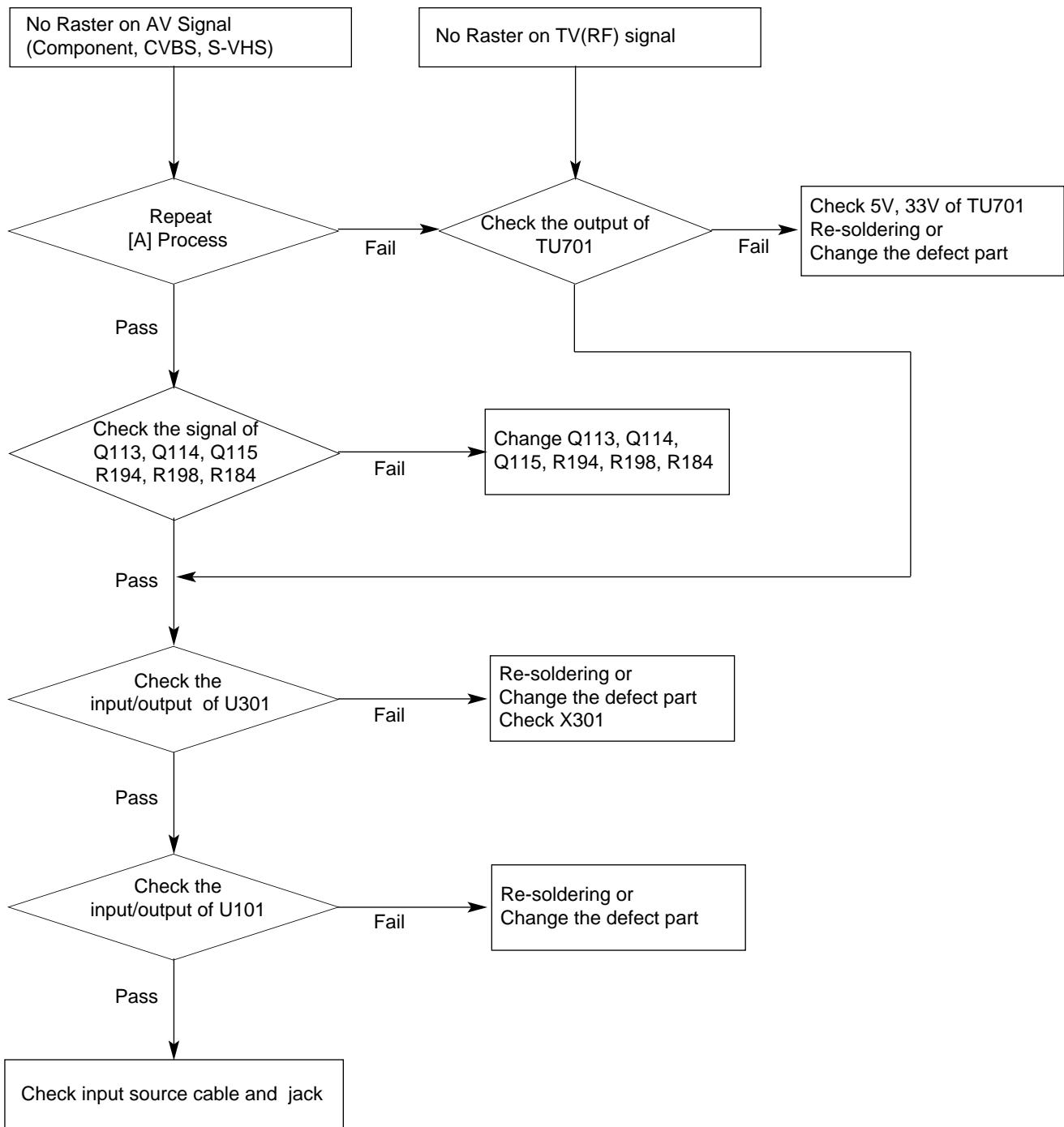
NO.	KEY	FUNTION	REMARK
1	POWER	To turn the TV on or off	
2	MUTE	To activate the mute function.	
3	P-CHECK	To check TV screen image easily.	Shortcut keys
4	S-CHECK	To check TV screen sound easily	Shortcut keys
5	ARC(23inch)	To select size of the main screen (Auto, 4:3, 16:9, 14:3, Zoom, Cinema Zoom)	Shortcut keys
6	CAPTION	Switch to closed caption broadcasting	
7	TXT	To toggle on/off the teletext mode	
8	TV/AV	External input	
9	IN-START	To enter adjustment mode when manufacturing the TV sets. In-Start→Vol±→Auto ADC→Vol±→W/B adjustment→ Exit two times(Adjustment completed)	Use the AV key to enter the screen W/B adjustment mode.
10	MPX	To select the multiple sound mode (Mono, Stereo or MPEG, DOLBY, Digital)	
11	EXIT	To release the adjustment mode	
12	APC(PSM)	To easily adjust the screen according to surrounding brightness	
13	ASC(SSM)	To easily adjust sound according to the program type	
14	MULTIMEDIA	External input	Shortcut keys
15	CH ±	To move channel up/down or to select a function displayed on the screen.	
16	VOL ±	To adjust the volume or accurately control a specific function.	
17	ENTER	To set a specific function or complete setting.	
18	CH-(OP1)	To use as a <b>red key</b> in the teletext mode	
19	CH+(OP2)	To use as a <b>green key</b> in the teletext mode	
20	SWAP(OP3)	To use as a <b>yellow key</b> in the teletext mode	
21	INPUT(OP4)	To use as a <b>blue key</b> in the teletext mode	
22	MENU	To select the functions such as video, voice, function or channel.	
23	IN-STOP	To set the delivery condition status after manufacturing the TV set.	
24	HOLD	Used as a hold key in the teletext mode (Page updating is stopped.)	
25	TIME	Displays the teletext time in the normal mode Enables to select the sub code in the teletext mode	
26	SIZE	Used as the size key in the teletext mode	
27	INDEX	Used as the index key in the teletext mode (Top index will be displayed if it is the top text.)	
28	UPDATE	Used as the update key in the teletext mode (Text will be displayed if the current page is updated.)	
29	MODE	Used as Mode in the teletext mode	
30	TIILT	To set IIC SW "0" or "1" in the adjustment mode	
31	0~9	To manually select the channel.	

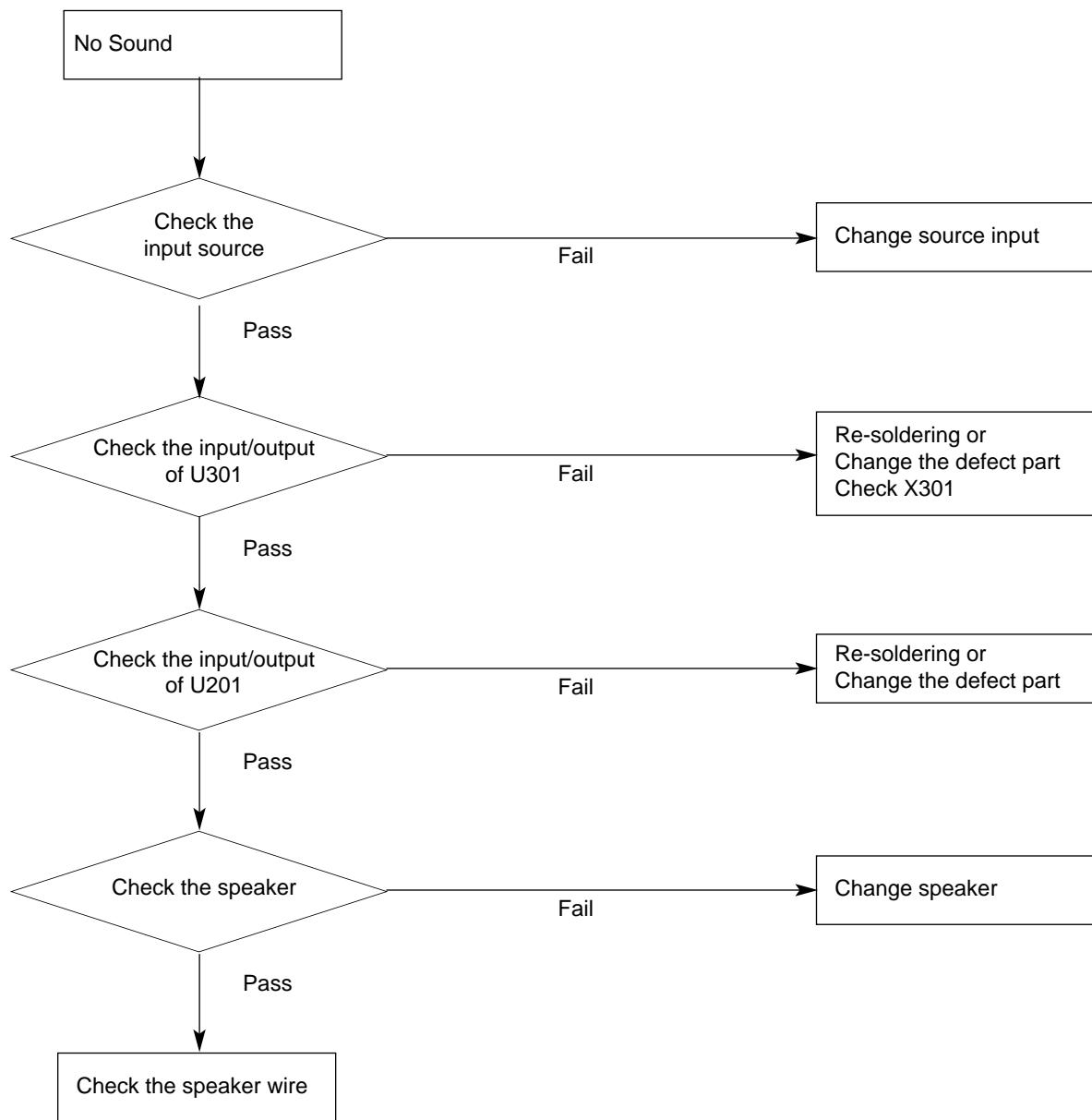


# TROUBLESHOOTING

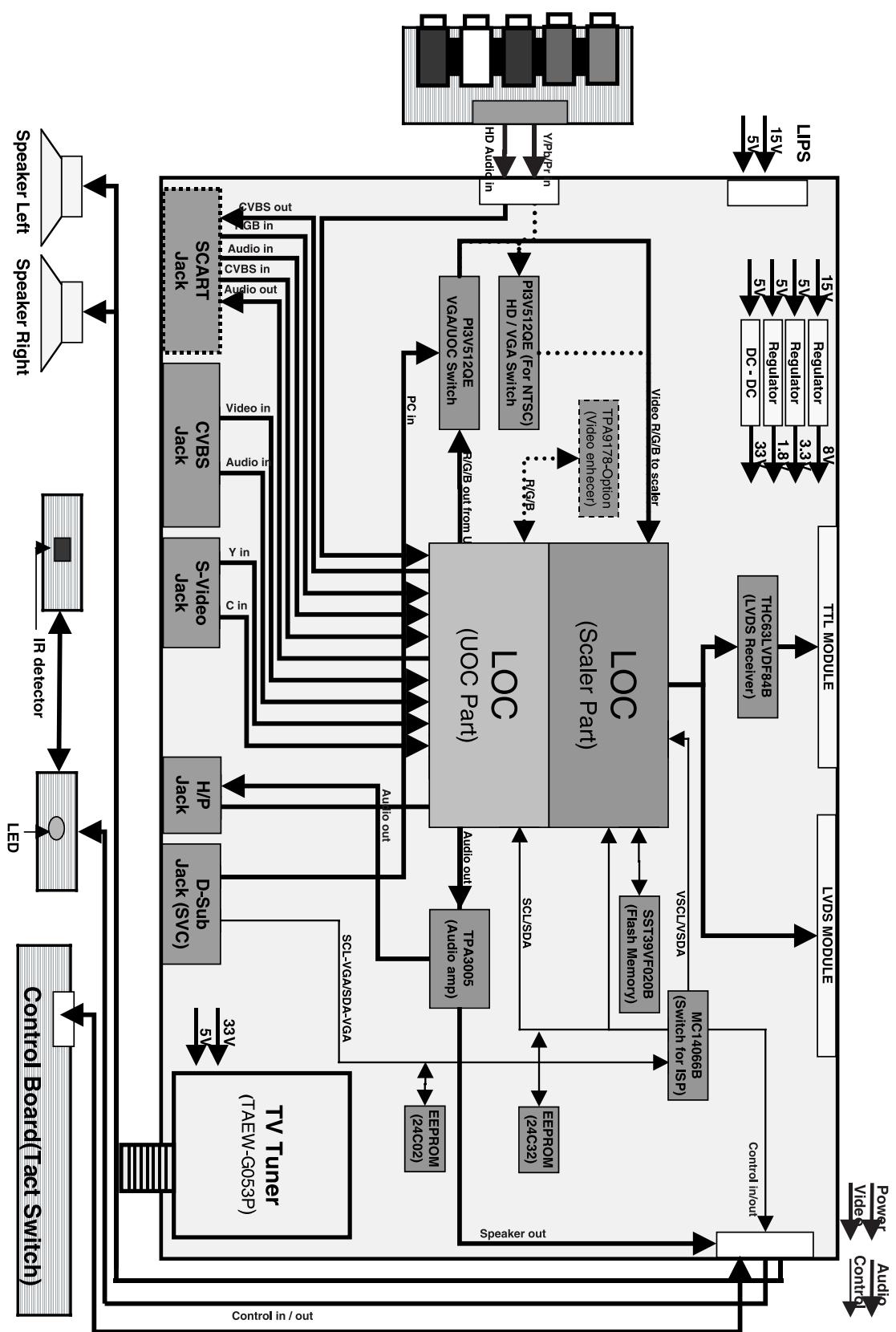








# BLOCK DIAGRAM



# BLOCK DIAGRAM DESCRIPTION

## **Power Supply Block (LIPS)**

This Block Generates DC Voltage (5V,15V) to Main Control system from AC Power (100-240 V, 50/60 Hz, 1.0A)

Also it has the inverter function that converts input voltage to AC Rms value for the LCD lamp.

## **DC/DC Converter block**

DC/DC Converter convert the input 5V,15V to proper 3.3V, 5V, 8V, 12V for Main control system.

For shooting heat trouble, we use the DC/DC converting IC

## **Audio Amplifier**

This block is composed of TPA3005D2 and peripheral device.

The function of the audio amplifier is that to amplify audio L / R signal transmitted from audio decoder. The audio signal is amplified according to pre-defined DC volume control curve.

## **Audio / Video / IF Decoder / Scaler**

This block is composed of LOC1 and peripheral devices.

### **1) Video Decoder**

This Block Selects input Video signals (like CVBS, Y/C, SCART RGB) and output RGB signal.

On decoding, We can control signal like Contrast, Brightness, Sharpness, Color, tint signals including Adaptive Comb Filter

### **2) Audio Decoder**

This block analyzes audio input signal through A/V Jack and PC audio and Tuner IF.

The analyzed signals transmitted to audio amplifier

On decoding, We can control signal like Bass, treble.

### **3) IF Decoder**

This block can change IF signal to audio and video signal that transmitted to Video/audio decoder.

### **4) Scaler**

This IC includes A/D Converter and LVDS Transmitter

This IC is directly Inputted Analog Signal and transmits it to LCD Module

### **5) Micom**

This block controls each IC through IIC communication line.

## **LVDS Rx (DTC34LF86L)**

It is composed of DTC34LF86L/THC63LVDF84B.

The LVDS Rx converts the LVDS data streams back into 24bits of CMOS/TTL data with Falling edge or rising edge clock for convenient with variety of LCD panel controllers.

## **Switch IC (PI3V512QE)**

It is composed of PI3V512QE.

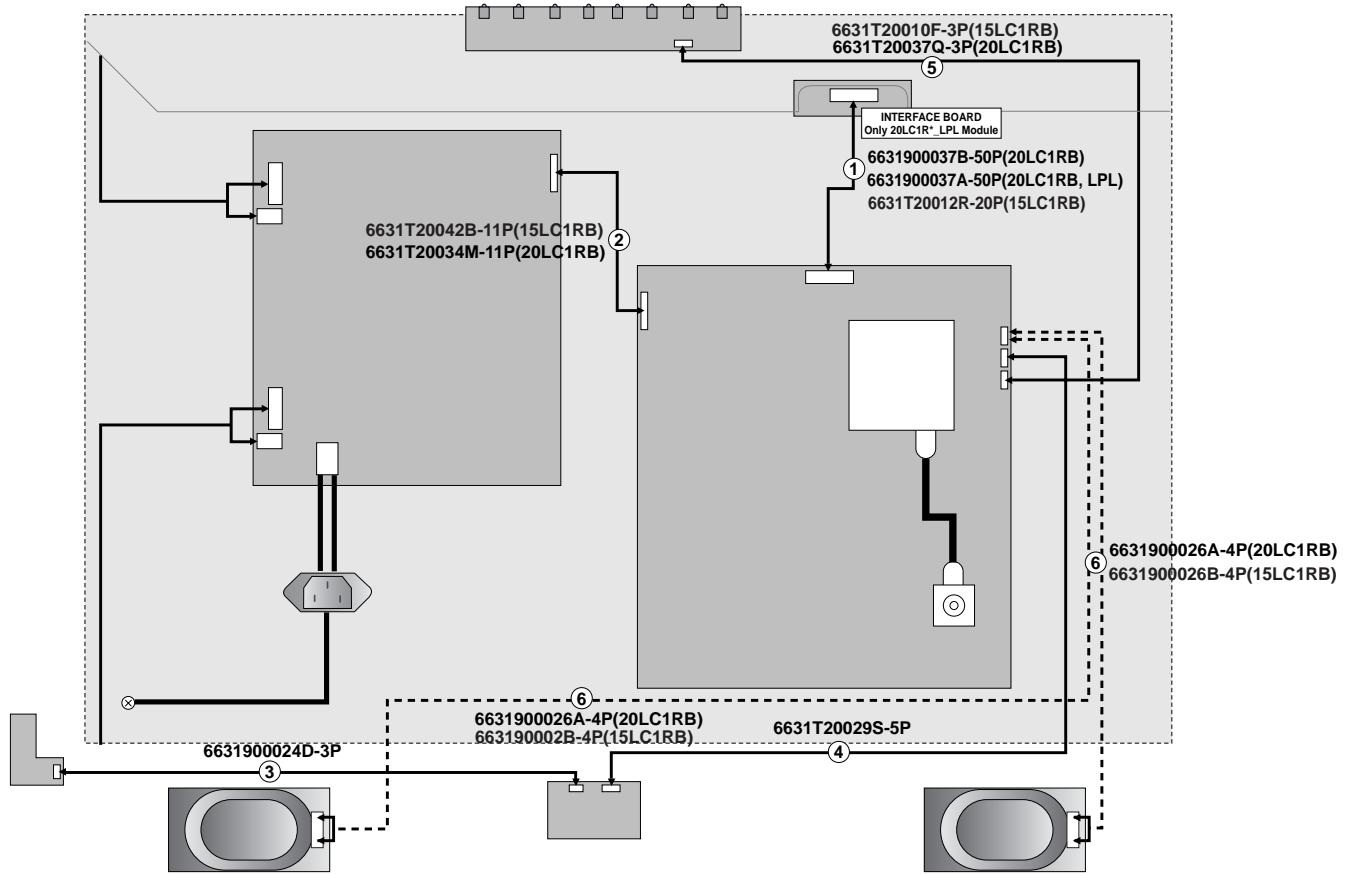
This IC selects between D-sub RGB signal and LOC1 RGB signal, and it transmits the selected signal to video signal processor.

## **TUNER**

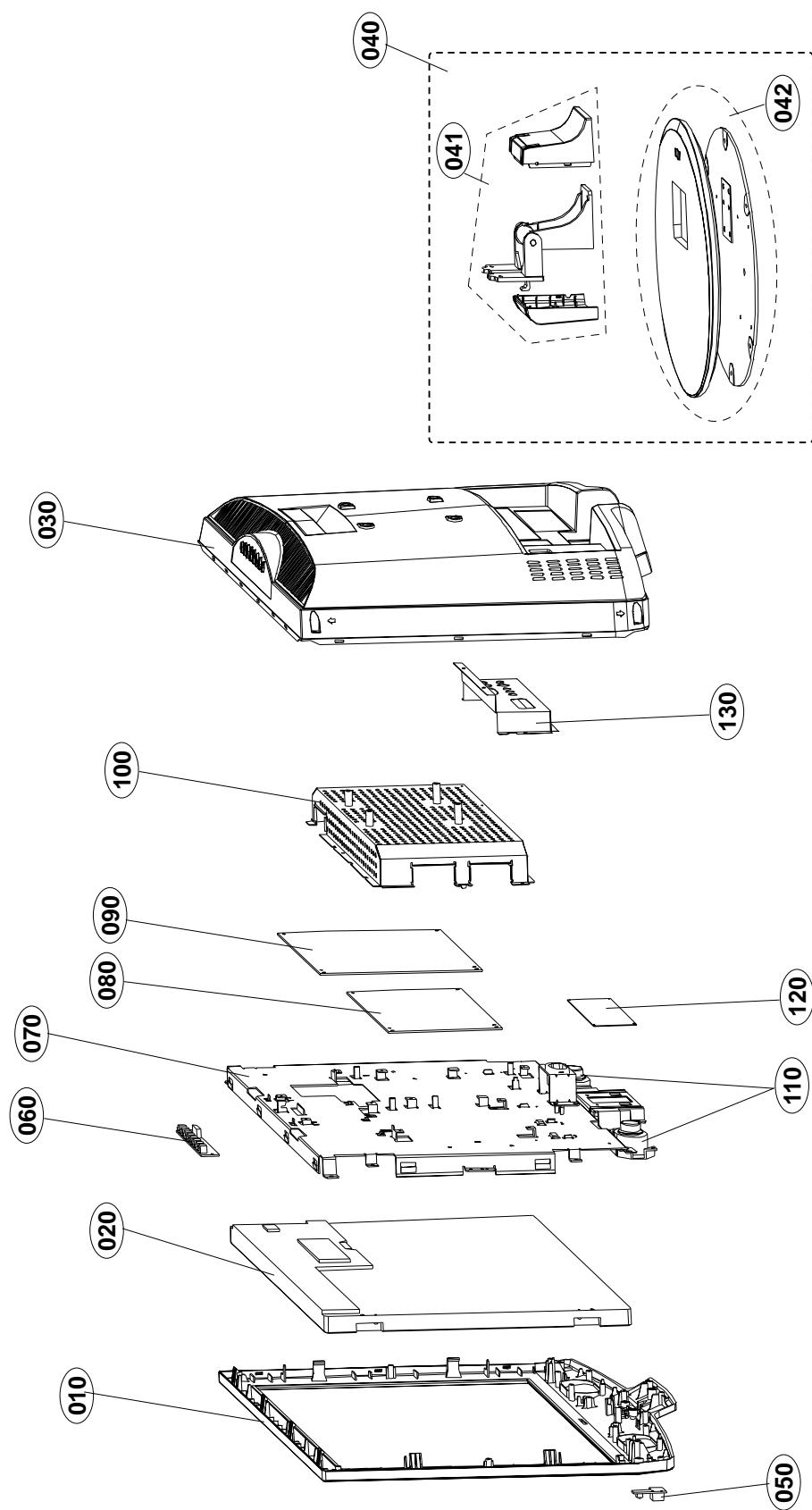
Micom controls this through IIC Line.

TUNER makes IF and transmits IF signal to LOC1.

# WIRING DIAGRAM



## EXPLODED VIEW



# EXPLODED VIEW PARTS LIST

No.	PART NO.	DESCRIPTION
010	30919B0002M	CABINET ASSEMBLY, <b>15LC1R</b> BRAND . NORTH AMERICA(BK, SET)
	30919B0002J	CABINET ASSEMBLY, <b>15LC1R-MG</b> BRAND . NORTH AMERICA- <b>CSKD</b>
	30919D0001G	CABINET ASSEMBLY, <b>20LC1R-MG</b> (BK) BRAND 3090TKD006 SET
	30919D0001H	CABINET ASSEMBLY, <b>20LC1R-MG</b> (BK) BRAND 3090TKD006 <b>C/SKD</b>
020	6304FLP234A	LCD(LIQUID CRYSTAL DISPLAY), <b>LC150X02-TL01</b> LG PHILIPS TFT COLOR TN LAMP MULTI
	6304FLP188A	LCD(LIQUID CRYSTAL DISPLAY), <b>LC201V02-A3KA</b> LG PHILIPS TFT COLOR PB FREE MODULE , SS D-IC
030	38099000013E	BACK COVER ASSEMBLY, <b>15LC1</b> 2PHONE FOR N.A
	38099000002L	BACK COVER ASSEMBLY, <b>20LC1R-MG</b> (USA) NON SET(BK)
	38099000002M	BACK COVER ASSEMBLY, <b>20LC1R-MG</b> (USA) NON <b>C/SKD</b> (BK)
040	3043900003F	TILT SWIVEL ASSEMBLY, <b>15LC1R-MG</b> 49509K0009A N/A NO PRINTNG
	3043900002B	TILT SWIVEL ASSEMBLY, <b>20LC1R-ZB</b> 3550TKK974
041	3043900039A	TILT SWIVEL ASSEMBLY, <b>15LC1</b> . STAND BODY ASSY- <b>CSKD</b>
	3043900010B	TILT SWIVEL ASSEMBLY, <b>20LC1RB-ZG</b> NON HINGE ASSY(BK)- <b>CSKD</b>
042	3043900040C	TILT SWIVEL ASSEMBLY, <b>15LC1R-MG</b> (N/A) . STAND BASE ASSY(BK, NO PRINT)- <b>CSKD</b>
	3043900011B	TILT SWIVEL ASSEMBLY, <b>20LC1</b> NON STAND BASE ASSY(FOR USA)- <b>CSKD</b>
050	68719ST799B	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 LC1R ALEULFX LED
	68719ST799E	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 20LC1R-ZG SLEELFP LED+IR- <b>CSKD</b>
060	68719ST801A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>1XLC1</b> ANEULFX CONTROL
	68719ST956A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>15LC1R</b> SNRULFT CONTROL- <b>CSKD</b>
	68719ST798A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>2XLC1</b> ALEULFX CONTROL
	68719ST798B	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>2XLC1</b> SLEELFP CONTROL- <b>CSKD</b>
070	49519S0004B	METAL ASSEMBLY, FRAME, MAIN ASSY- <b>15LC1-LPL-TN</b>
	49519S0004F	METAL ASSEMBLY, FRAME, MAIN ASSY- <b>15LC1-LPL TN C/SKD</b>
	49519S0001A	METAL ASSEMBLY, FRAME, <b>20LC1</b>
	49519S0001B	METAL ASSEMBLY, FRAME, <b>20LC1R-ZB(C/SKD)</b>
080	6871TPT318B	PWB(PCB) ASSEMBLY,POWER, MFT 4-LAMP POWER TOTAL BRAND . <b>15LC1R</b>
	6871TPT319A	PWB(PCB) ASSEMBLY,POWER, 6-LAMP TV/MNT/MFT POWER TOTAL BRAND . <b>-20LC1R</b>
090	33139N1011C	MAIN TOTAL ASSEMBLY, <b>15LC1R-MG</b> BRAND CL-81(USA)
	33139N1015A	MAIN TOTAL ASSEMBLY, <b>15LC1RX-MG(SKD)</b> BRAND CL-81
	33139N2021A	MAIN TOTAL ASSEMBLY, <b>20LC1R-MG</b> (C) BRAND CL-81
	33139N2021C	MAIN TOTAL ASSEMBLY, <b>20LC1R-MG SKD</b> (C) BRAND CL-81
100	49519K0117B	METAL ASSEMBLY, SHIELD, AV NTSC <b>15LC1</b>
	49519K0117E	METAL ASSEMBLY, SHIELD, 15LC1R-MG(NTSC, USA) AV SHIELD PHANTOM- <b>20LC1R</b>
110	6400GTTX02A	SPEAKER,FULLRANGE, EF1527C-6428-6 TOPTONE FULL-RANGE(GENERAL) 160HM 5/7W 82DB OTHERS 40°70 210HZ
120	68719ST077A	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>20LC1R</b> ALEULFX HIROSE- <b>ONLY 20LC1R</b>
	68719ST077B	PWB(PCB) ASSEMBLY,SUB, SUB T.T CL81 <b>20LC1R</b> SLEELFP INTERFACE(HIROSE)- <b>ONLY 20LC1R</b> , CSKD
130	49519K0116A	METAL ASSEMBLY, REAR <b>15LC1</b>
	49519K0116B	METAL ASSEMBLY, REAR <b>15LC1 C/SKD</b>
	4950TKA372A	METAL, SHIELD, MAIN <b>20LC1</b>
	4950TKA372D	METAL, SHIELD, MAIN <b>20LC1, C/SKD</b>









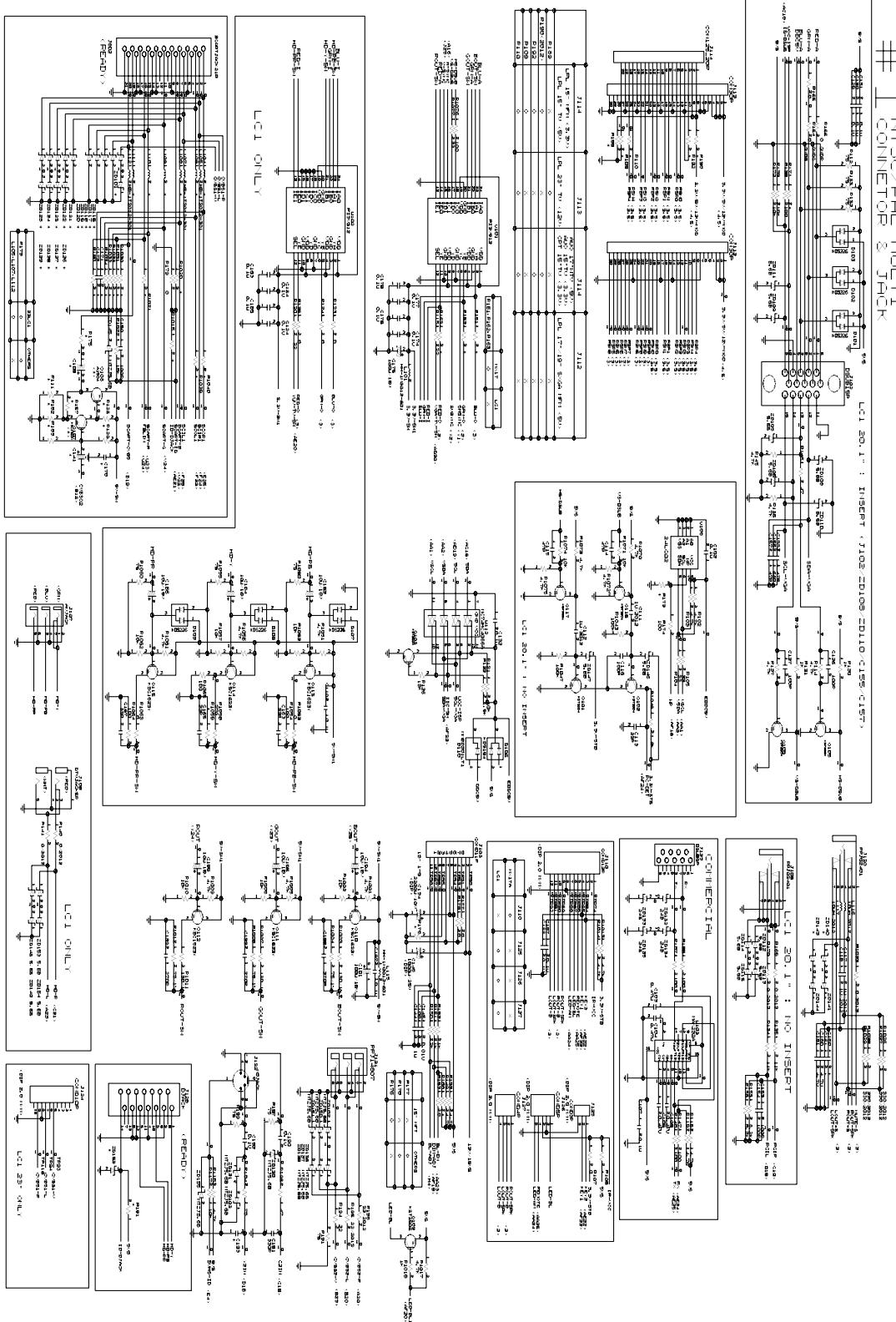




DATE: 2006.01.20.				
*S	*AL	LOC. NO.	PART NO.	DESCRIPTION / SPECIFICATION
		SW502	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW503	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW504	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW505	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW506	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW507	140-058B	EVQ PB2 05K MATUSHITA NON 1
		SW508	140-058B	EVQ PB2 05K MATUSHITA NON 1
		ZD502	0DZ560009CF	MTZJ5.6B TP ROHM-K DO34 0.5
		ZD505	0DZ560009CF	MTZJ5.6B TP ROHM-K DO34 0.5

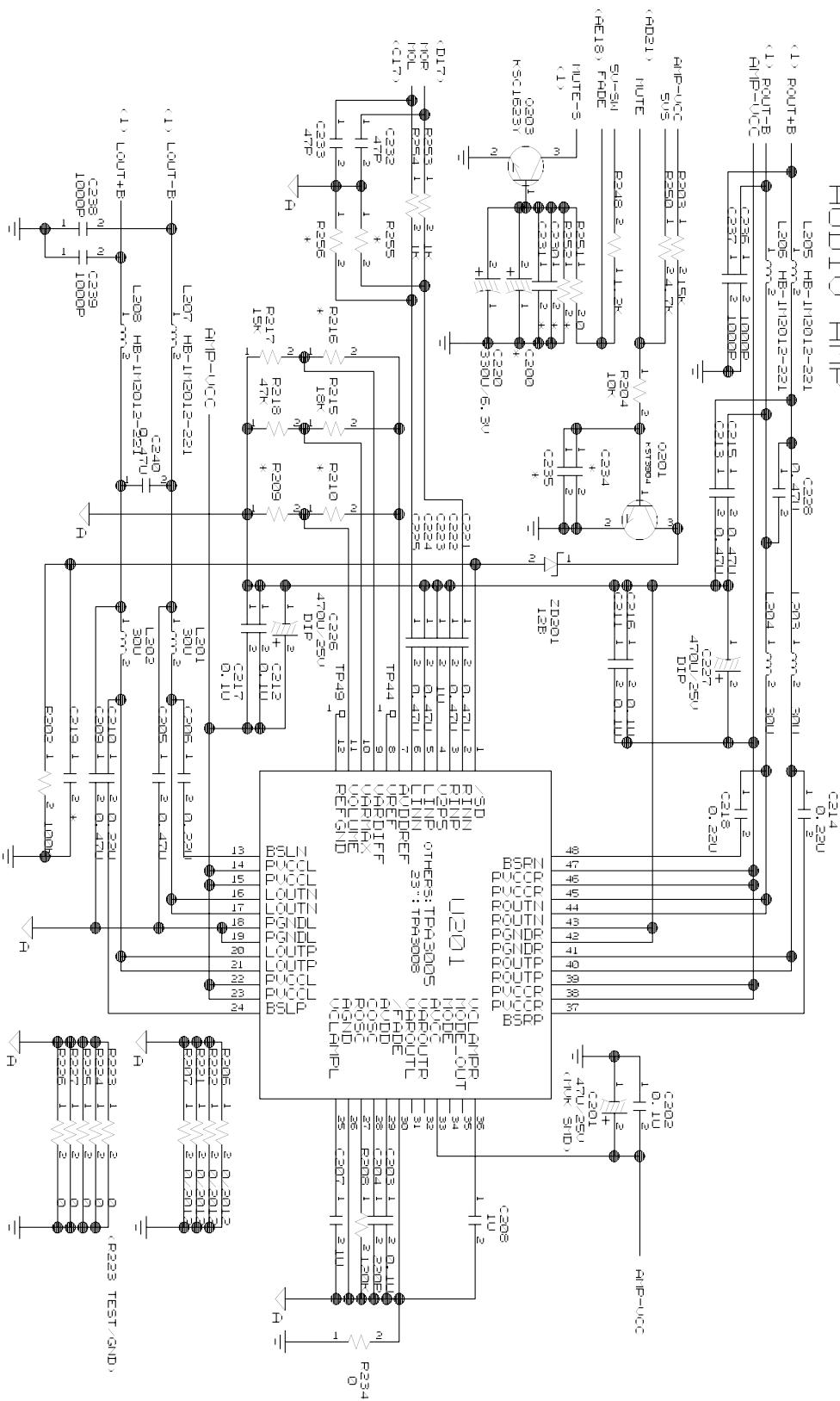
**BLUE BIRD III-HX17A, LCI 15" / 17" / 20.1" / 23"**

NTSC/PHL MULTI CONNECTOR

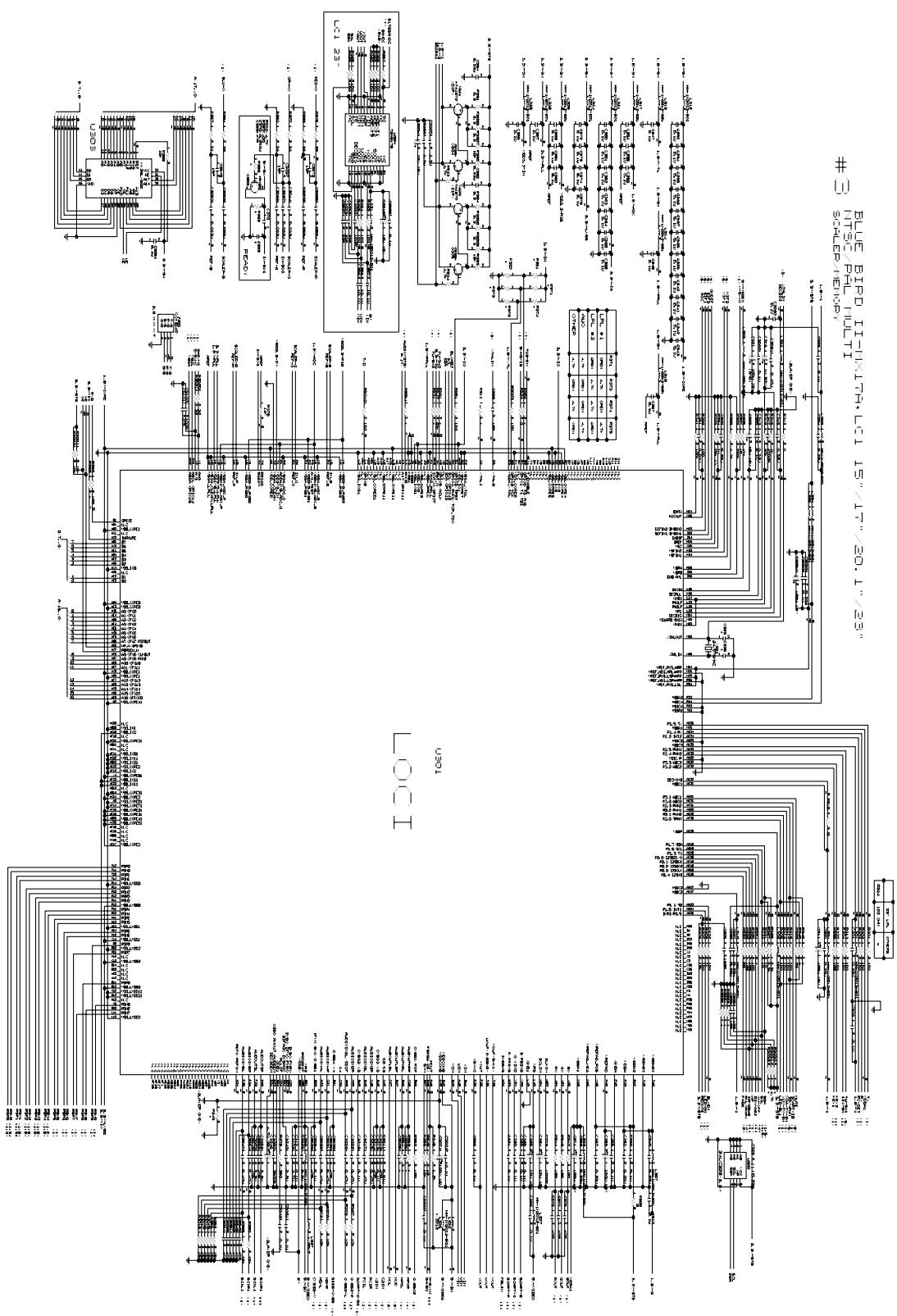


BLUE BIRD II-MX.17A, LC1 15" / 17" / 20". 1" / 23"

## #2 NTSC/PAL MULTI AUDIO AMP

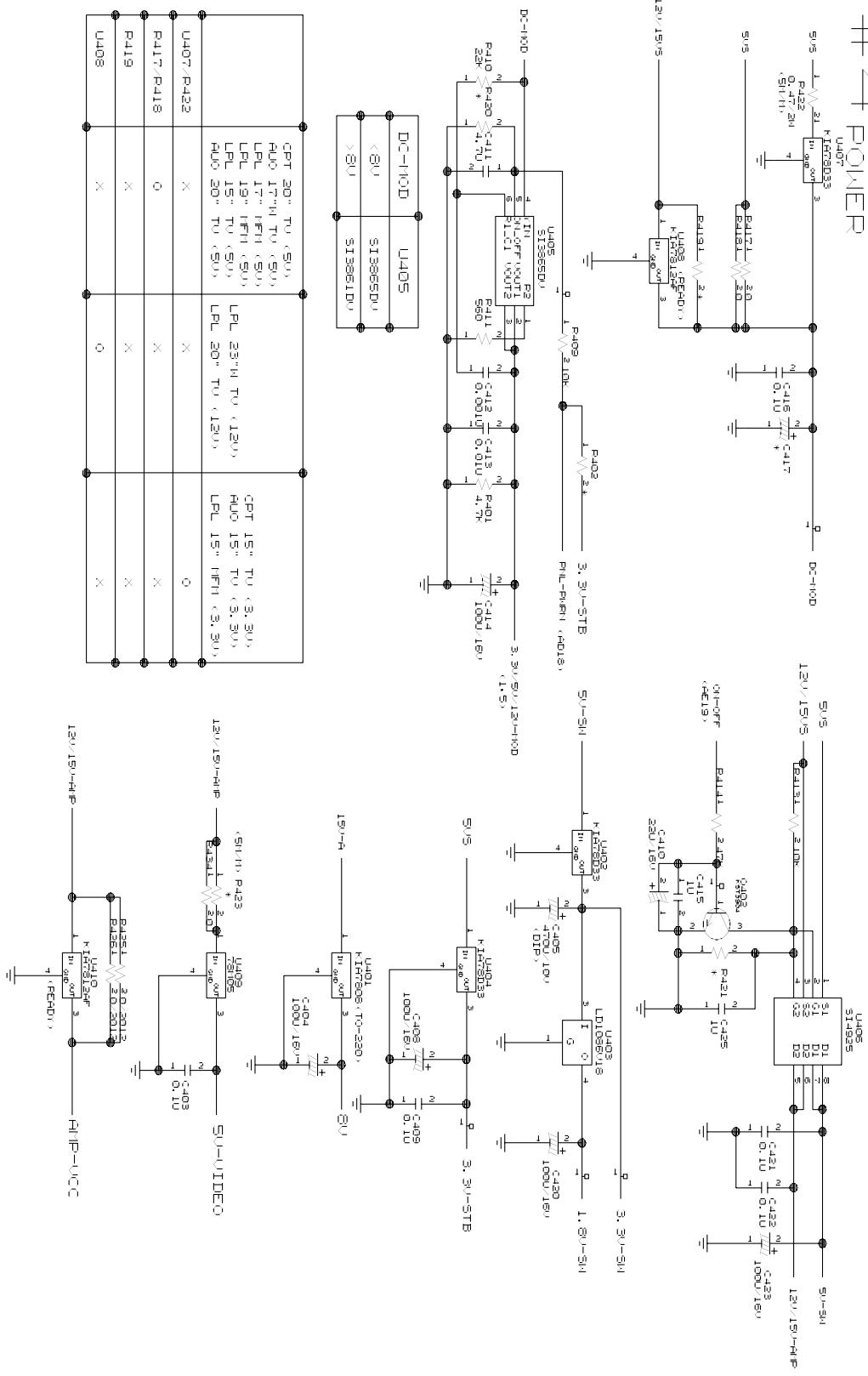


# 3  
BLUE BIRD III-MULTI-LCD 15" / 17" / 20.1" / 23"  
NTSC PAL MULTI  
SCALER-HD-CP



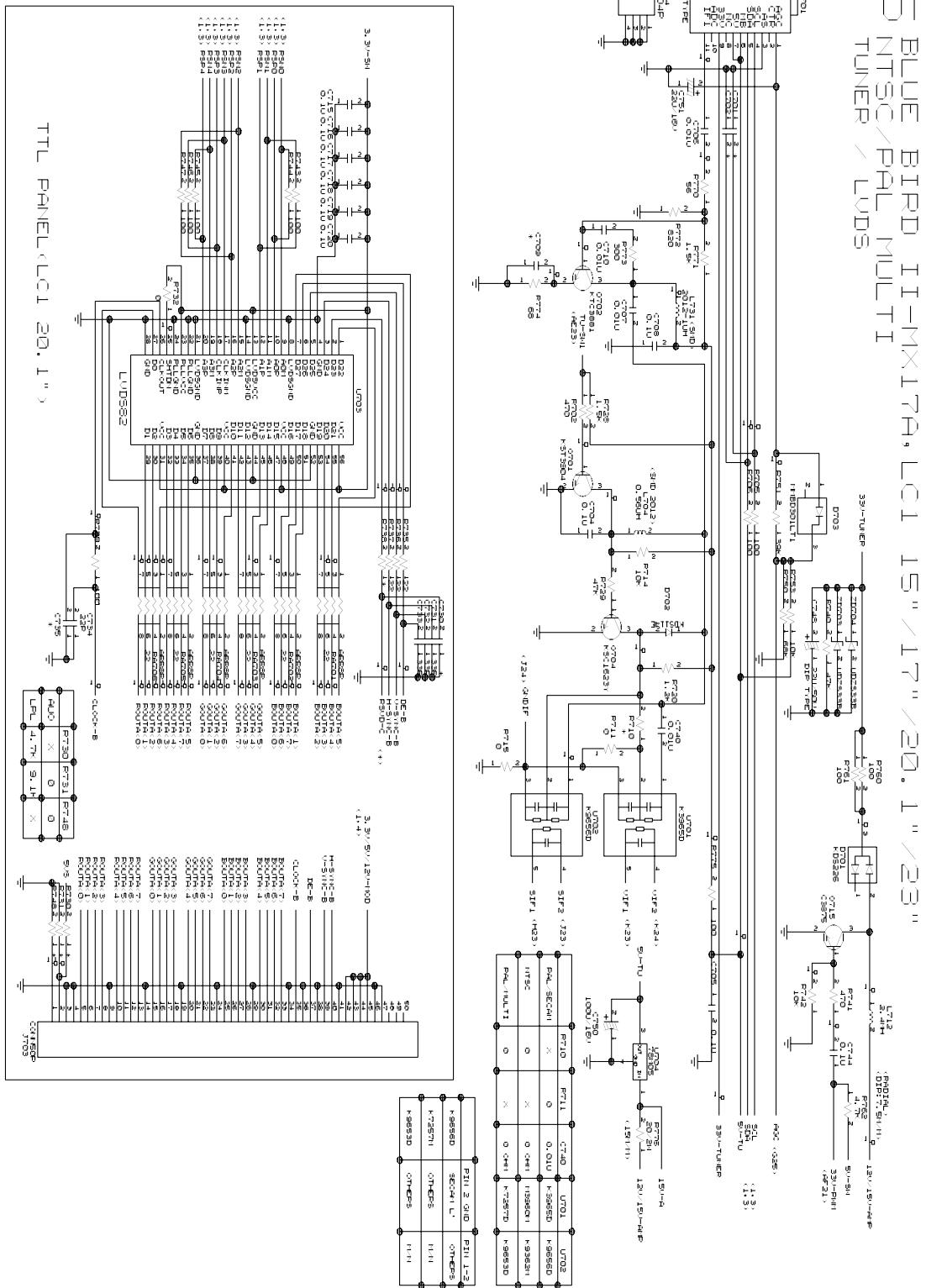
# BLUE BIRD I-MIX/LC/L 15" / 17" / 20" / 23"

#4  
NTSC/PAL POWER



#5 BLUE BIRD I-MIX LCI 15" / 17" / 20" / 21" / 23"

NTSC / PAL TUNER / LUDS





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